

MOSFET

OptiMOS[™]5 Power-Transistor, 80 V

Features

- Ideal for high-frequency switching
 Optimized for chargers
 100% avalanche tested
 Superior thermal resistance

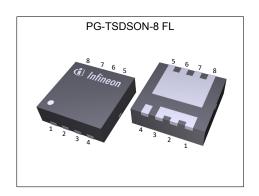
- N-channel, logic level
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

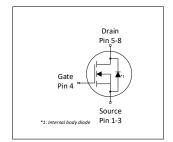
Product validation

Qualified according to JEDEC Standard

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
$V_{ t DS}$	80	V
$R_{\mathrm{DS(on),max}}$	7.8	mΩ
I_{D}	64	A
Qoss	23	nC
Q _G (0V4.5V)	11	nC











Type / Ordering Code	Package	Marking	Related Links
ISZ0602NLS	PG-TSDSON-8 FL	0602NL	-

OptiMOS[™]5 Power-Transistor, 80 V ISZ0602NLS



Table of Contents

Description	1
Maximum ratings	3
Thermal characteristics	3
Electrical characteristics	4
Electrical characteristics diagrams	6
Package Outlines	0
Revision History	1
Trademarks 1	1
Disclaimer	1

OptiMOS[™]5 Power-Transistor, 80 V ISZ0602NLS



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Dougranton	Cumbal	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	-	64 49 12	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	256	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	61	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	60 2.1	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature T_j , T_j		-55	-	150	°C	IEC climatic category; DIN IEC 68-1 55/150/56

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Farameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	1.2	2.1	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Device on PCB, 6 cm² cooling area ²⁾	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	0	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.1	1.6	2.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=29\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	7.3 9.4	7.8 9.9	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =10 A
Gate resistance ¹⁾	R _G	-	1.5	-	Ω	-
Transconductance	g fs	-	47	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 Dynamic characteristics

Parameter	Ol	Values			11	Nata (Tant Oam dition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	1400	1860	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	220	290	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	10	13	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	5.6	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Rise time	t _r	-	10	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Turn-off delay time	$t_{ m d(off)}$	-	15	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω
Fall time	t _f	-	4.8	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =4.5 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Values				11:4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	4.3	-	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	2.3	-	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate to drain charge	Q_{gd}	-	3.9	-	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	5.8	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	11	15	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	3.0	-	V	V_{DD} =40 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	22	29	nC	V _{DD} =40 V, I _D =20 A, V _{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	20	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge	Qoss	-	23	-	nC	V _{DS} =40 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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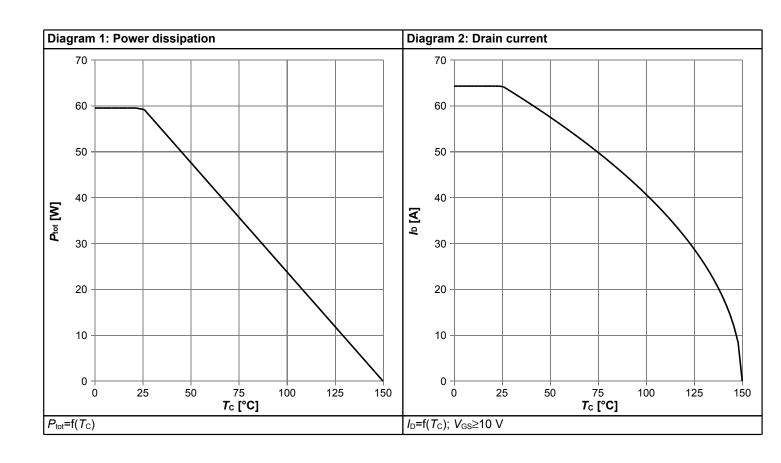


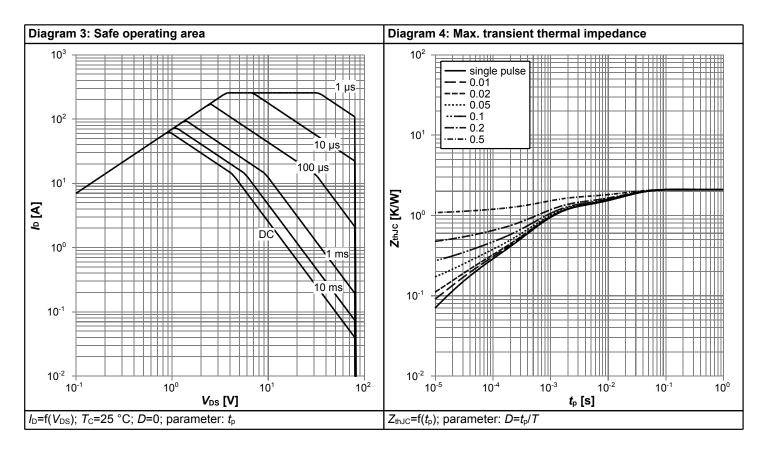
Table 7 Reverse diode

Parameter	Symbol		Values			Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	52	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	256	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.87	1.0	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	30	-	ns	V _R =40 V, I _F =20 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	23	_	nC	V_R =40 V, I_F =20 A, di_F/dt =100 A/µs

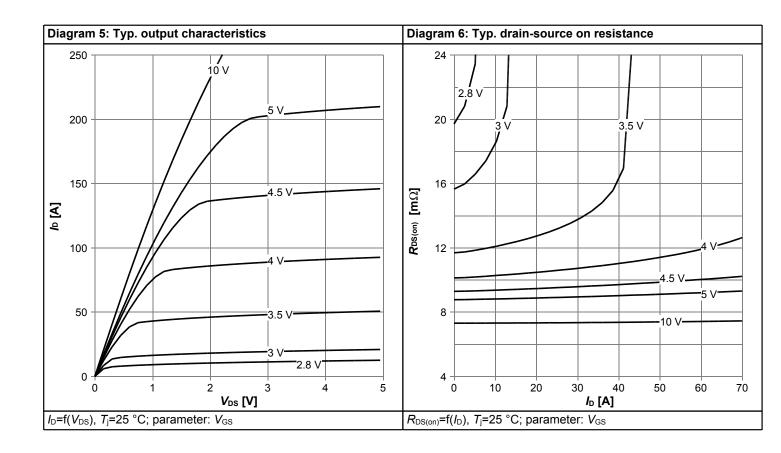


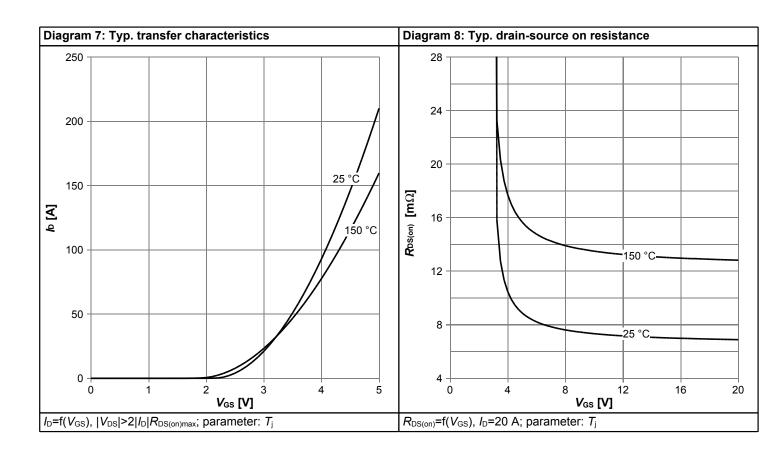
4 Electrical characteristics diagrams



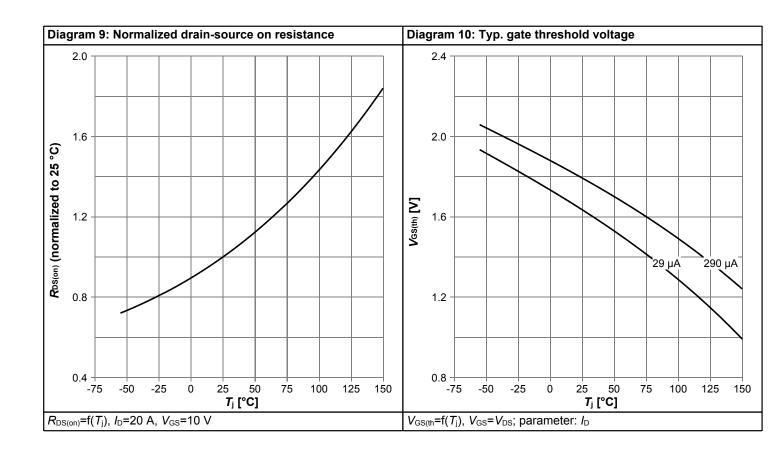


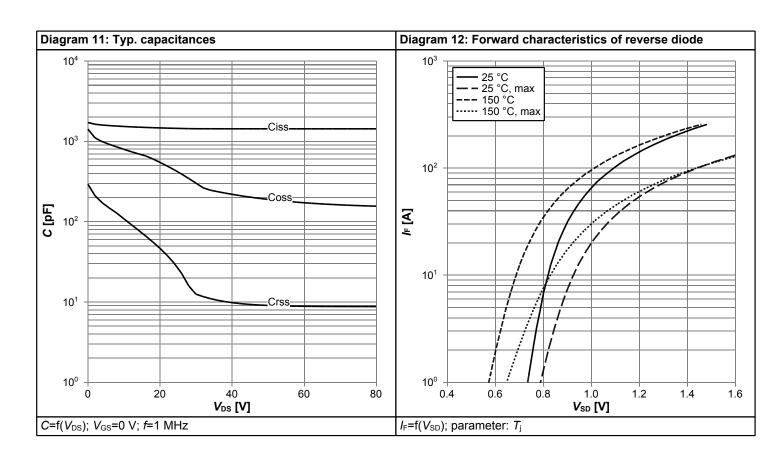




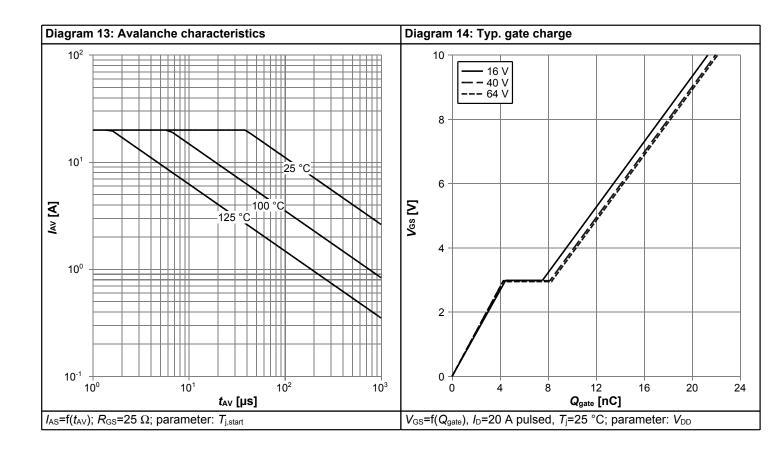


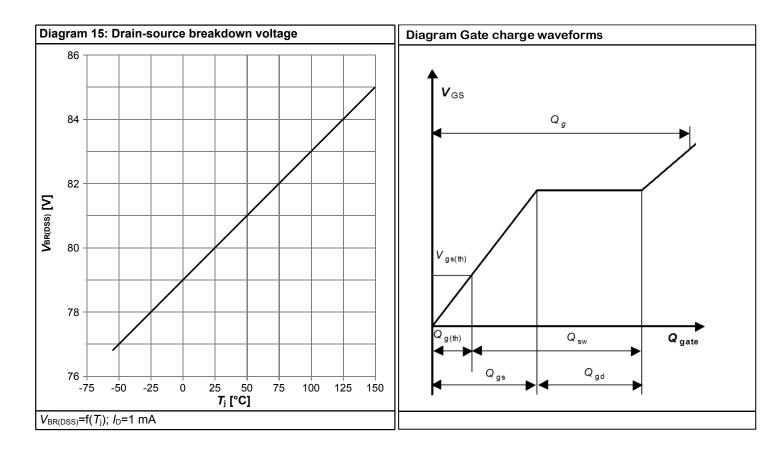






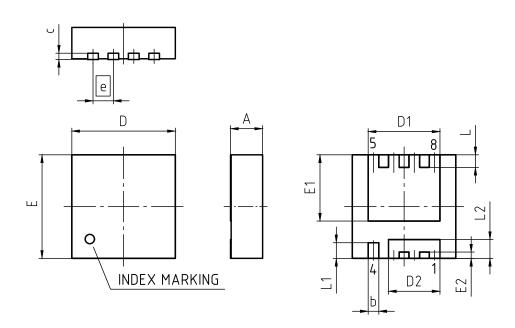








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDS	SON-8-U03			
REVISION: 03	DATE:	20.10.2020			
DIMENSIONS	MILLIN	IETERS			
DIMENSIONS	MIN.	MAX.			
Α	0.90	1.10			
b	0.24	0.44			
С	(0	.20)			
D	3.20	3.40			
D1	2.19	2.39			
D2	1.54	1.74			
E	3.20	3.40			
E1	2.01	2.21			
E2	0.10	0.30			
е	0.65				
L	0.30	0.50			
L1	0.40	0.60			
L2	0.50	0.70			
aaa	0.0	06			

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm

OptiMOS[™]5 Power-Transistor, 80 V ISZ0602NLS



Revision History

ISZ0602NLS

Revision: 2021-04-01, Rev. 2.1

Previous Revision

FIEVIOUS F	Fievious Revision						
Revision	Revision Date Subjects (major changes since last revision)						
2.0	2021-03-22	Release of final version					
2.1	2021-04-01	Update of features list					

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